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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/844,855	04/26/2001	Song-Hua Shi	42390P10937	1410
759	90 11/20/2002		. <u></u>	
Stephen M. De Klerk			EXAMINER	
Blakely, Sokoloff, Taylor & Zafman LLP Seventh Floor			OWENS, DOUGLAS W	
12400 Wilshire Boulevard Los Angeles, CA 90025-1026			ART UNIT	PAPER NUMBER
Los Aligeles, CA	- 70023-1020		2811	

Please find below and/or attached an Office communication concerning this application or proceeding.

			900
	Application No.	Applicant(s)	
•	09/844,855	SHI ET AL.	•
Office Action Summary	Examiner	Art Unit	
4 **	Douglas W Owens	2811	
The MAILING DATE of this communication app	ears on the cover sheet	with the correspondence add	Iress
Period for Reply A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, - Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b). Status	36(a). In no event, however, may within the statutory minimum of the vill apply and will expire SIX (6) Mode, cause the application to become	a reply be timely filed nirty (30) days will be considered timely. DNTHS from the mailing date of this con ABANDONED (35 U.S.C. § 133).	nmunication.
1) Responsive to communication(s) filed on 19 A	Nugust 2002 .		
2a)⊠ This action is FINAL . 2b)□ Thi	is action is non-final.		
3) Since this application is in condition for allowards closed in accordance with the practice under a Disposition of Claims			merits is
4)⊠ Claim(s) 1-28 is/are pending in the application			
4a) Of the above claim(s) is/are withdraw	vn from consideration.		
5) Claim(s) is/are allowed.			
6)⊠ Claim(s) <u>1-28</u> is/are rejected.			
7) Claim(s) is/are objected to.			
8) Claim(s) are subject to restriction and/or	election requirement.		
Application Papers			
9) The specification is objected to by the Examiner	•		
10) ☐ The drawing(s) filed on is/are: a) ☐ accep	ted or b)☐ objected to by	the Examiner.	
Applicant may not request that any objection to the	• • • • • • • • • • • • • • • • • • • •	, , ,	
11) The proposed drawing correction filed on	•	disapproved by the Examiner	
If approved, corrected drawings are required in rep	•		
12)☐ The oath or declaration is objected to by the Exa	aminer.		
Priority under 35 U.S.C. §§ 119 and 120			
13) Acknowledgment is made of a claim for foreign	priority under 35 U.S.C.	§ 119(a)-(d) or (f).	
a) ☐ All b) ☐ Some * c) ☐ None of:			
1. Certified copies of the priority documents	have been received.		1
2. Certified copies of the priority documents	have been received in	Application No	
 3. Copies of the certified copies of the priori application from the International Bure * See the attached detailed Office action for a list of 	eau (PCT Rule 17.2(a)).		age
14) Acknowledgment is made of a claim for domestic	priority under 35 U.S.C.	. § 119(e) (to a provisional a	pplication).
a) ☐ The translation of the foreign language prov 15)☐ Acknowledgment is made of a claim for domestic	visional application has t	peen received.	,
Attachment(s)			
Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of	Summary (PTO-413) Paper No(s). Informal Patent Application (PTO-	

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DETAILED ACTION

Claim Rejections - 35 USC § 112

- The following is a quotation of the second paragraph of 35 U.S.C. 112:
 The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 2. Claims 1-21, 25 and 26 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

Claims 1 and 25 contains the trademark/trade name Siloxirane[™]. Where a trademark or trade name is used in a claim as a limitation to identify or describe a particular material or product, the claim does not comply with the requirements of 35 U.S.C. 112, second paragraph. See *Ex parte Simpson*, 218 USPQ 1020 (Bd. App. 1982). The claim scope is uncertain since the trademark or trade name cannot be used properly to identify any particular material or product. A trademark or trade name is used to identify a source of goods, and not the goods themselves. Thus, a trademark or trade name does not identify or describe the goods associated with the trademark or trade name. In the present case, the trademark/trade name is used to identify/describe a resin containing O-Si-O groups, along with a reactive organic functional group, and an aromatic group, whereas Applicant is reciting a resin containing O-Si-O groups, along with a reactive organic functional group, and an organic chain segment, and, accordingly, the identification/description is indefinite.

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Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 1, 9-11, 13-17 and 19-28 are rejected under 35 U.S.C. 103(a) as being unpatentable over US patent No. 6,180,696 to Wong et al. in view of US patent No. 5,026,816 to Keehan.

Regarding claim 1, Wong et al. teaches a no-flow material comprising: an epoxy resin (first line of abstract);

at least one agent acting as a cross-linking hardener (Col. 5, lines 1 and 2) and a curing catalyst capable of catalyzing the curing of the epoxy resin (Col. 5, lines 13-22); and

a fluxing agent (Col. 5, lines 23-47).

Wong et al. does not teach a Siloxirane[™] epoxy resin.

Keehan discloses a SiloxiraneTM epoxy resin (Col. 3, lines 53-56; Col. 4, lines 3-6 and 36-39). It would have been obvious to one of ordinary skill in the art to incorporate the SiloxiraneTM epoxy resin taught by Keehan into the device taught by Wong et al., since SiloxiraneTM epoxy resin is a known material that is well suited for the intended use. The selection of a known material based on its suitability for its intended use supported a *prima facie* obviousness determination in *Sinclair & Carroll Co. v.*Interchemical Corp., 325 U.S. 327, 65 USPQ 297 (1945). It would have been further

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obvious to employ the SiloxiraneTM epoxy resin since it has enhanced chemical and corrosion resistance, high adhesive strength, high heat deflection temperatures and toughness (Keehan, Col. 3, lines 17-19).

Regarding claim 9, the proposed material of Wong et al. and Keehan discloses no-flow underfill, as recited above, further disclosing wherein the agent acting as a cross-linking hardener and a catalyst includes both a hardener and a catalyst (Wong et al., Col. 5, lines 1 and 2, and 13-22).

Regarding claim 10, the proposed material of Wong et al. and Keehan teach a no-flow underfill, further teaching wherein the agent acting as a cross-linking hardener is an anhydride (Wong et al., Col. 5, lines 1-5).

Regarding claim 11, the proposed material of Wong et al. and Keehan teach a no-flow material, wherein the catalyst is an imidazolium salt (Wong et al., Col. 5, line 21).

Regarding claim 13, Wong et al. teaches a no-flow underfill, wherein the fluxing agent is glycerol – $C_3H_5(OH)_3$ – which has three hydroxyl (OH) groups (Col. 5, line 44).

Regarding claims 14 and 15, Wong et al. teaches a no-flow underfill, further comprising a silane coupling agent as an adhesion promoter (Col. 6, lines 1 and 2).

Regarding claim 16, Wong et al. teaches a no-flow underfill, further comprising a non-ionic surfactant (Col. 6, lines 10-20).

Regarding claim 17, Wong et al. teaches a no-flow underfill, wherein the surfactant is a polyol (Col. 6, line 17).

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Regarding claims 19 and 20, neither Wong et al. nor Keehan teach a no-flow underfill including silver flakes. Wong et al. teaches that "...the epoxy material may also include various additives known to those skilled in the art...to obtain...better thermal or electrical conductivity...". (Col. 14, lines 27-33). It is known in the art to use silver flakes to provide electrical conductivity (as admitted by Applicant in the prior art section [0021]). It is also known to use silver flakes to provide thermal conductivity. It would have been obvious to one of ordinary skill to add the silver flakes too obtain better electrical and thermal conductivity, which Wong teaches is desirable.

Regarding claim 21, neither Wong et al. nor Keehan teach a no-flow underfill wherein the thermally conductive particles are diamond. It would have been obvious to one of ordinary skill in the art to use a known material that is well suited for the intended use as discussed above. Wong et al. further discusses that it is desirable to enhance the thermal conductivity as discussed above.

Regarding claims 22-24 and 27, the proposed material of Wong et al. and Keehan teach a no-flow underfill, as recited above, including the limitations recited in claim 22.

Regarding claims 25 and 28, Wong et al. and Keehan teach a no-flow underfill, as recited above, including the limitations cited in claim 25 noting that the teaching of Wong et al. is for use in flip-chip technology. It is understood in the art that flip chip technology refers to a device, wherein the die and substrate have contact and bond pads, respectively, wherein conductive bumps contact the pads; this being the standard means by which a "flipped" chip is electrically connected to a substrate.

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5. Claims 2-8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Wong et al. and Keehan as applied to claim 1 above, and further in view of Japanese Patent No. 61112086 to Inokuchi et al.

Regarding claim 2, Wong et al. and Keehan teach a no-flow underfill, as recited above, further teaching wherein the Siloxirane is represented by

$$R1 - R3 - R2$$

where:

R1 includes SiO₂ (see final compound of Keehan, displayed across Cols. 7 and 8);

R2 is a reactive organic functional group (see the oxirane group in the final compound); and

R3 is an organic chain segment (see the aliphatic moiety in the final compound).

Alternatively, Inokuchi et al. teaches a Siloxirane[™] resin represented by

$$R1 - R3 - R2$$

Where R1 – R3 – R2 have the same meaning as above (see the cyclic oxirane attached to the short chain which is attached to the Si containing group, Figure 1, page 1022, Japanese Patent).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the proposed material as disclosed by Wong et al. and Keehan by providing for a SiloxiraneTM resin represented by R1 – R3 – R2 where R1 – R3 – R2 have the same meaning as above, as proposed by Inokuchi et al. to obtain the

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benefit of providing for the compound to be free of the strong UV chromophores that are present in an aromatic ring epoxy resin, as taught by Wong et al. (Col 4, lines 46-49).

Regarding claims 3 and 18, the proposed material of Wong et al., Keehan, and Inokuchi et al. teach a no-flow underfill, as recited above, with the exception of the explicit disclosure of R1 being a surface-grafted fused silica particle with a size less than 50 microns. It would have been obvious to one of ordinary skill in the art to select fused silica since it is a known material that is well suited for the intended use, as discussed above. With regard to the size of the silica particle, it has been held that arriving at result effective variables only requires ordinary skill in the art.

Regarding claim 4, the proposed material of Wong et al., Keehan, and Inokuchi et al. discloses a no-flow underfill, as recited above, further disclosing wherein R1 is a cyclic SiO₂ (Keehan, final product illustrated across Cols. 7 and 8).

Regarding claim 5, Wong et al., Keehan, and Inokuchi et al. teaches a no-flow underfill, as recited above, further disclosing wherein R1 includes an oxygen atom linked to the silica particle, R3 being linked to the oxygen atom (Keehan, final product illustrated across Cols. 7 and 8, where a silicon ion from the silica particle is linked to an oxygen atom which is linked to an R3 group (i.e., an organic chain segment)).

Regarding claim 6, Wong et al., Keehan, and Inokuchi et al. teaches a no-flow underfill, wherein R2 includes the oxirane group (Keenhan, final product, Cols. 7 and 8 or alternatively Inokuchi et al., Figs. 1 or 2, page 1022).

Regarding claim 7, Wong et al., Keehan, and Inokuchi et al. teach a no-flow underfill, as recited above, wherein R2 is an oxirane group wherein R3 and R' are

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attached to one of its two carbons and R" and R" are attached to the other carbon and where R', R" and R" are hydrogen or alkyl groups (Inokuchi et al., Fig. 2, page 1022).

Regarding claim 8, Wong et al., Keehan, and Inokuchi et al. teach a no-flow underfill, as recited above, wherein R1 is attached to R3 which is attached to R2 and wherein R2 is one of the oxirane groups illustrated in claim 8 groups (Inokuchi et al., Fig. 2).

Response to Arguments

6. Applicant's arguments filed August 19, 2002 have been fully considered but they are not persuasive.

The applicant argues that claims 1-21, 25 and 26 are definite because the appropriate capitalization and trademark symbol have been included in the claim. This is not convincing because the claim scope is uncertain since the trademark or trade name cannot be used properly to identify any particular material or product. A trademark or trade name is used to identify a source of goods, and not the goods themselves. Thus, a trademark or trade name does not identify or describe the goods associated with the trademark or trade name.

The applicant argues that it would not have been obvious to one of ordinary skill in the art to incorporate SiloxiraneTM into the teaching of Wong et al. because the applicant is a co-inventor in the Wong patent and did not know the advantages of using SiloxiraneTM in a no-flow underfill material. The assertion that the applicant was not aware of the teaching of Keehan does not refute the fact that the knowledge was generally available to anyone having ordinary skill in the art, even if the applicant is very

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familiar with the art. Additionally, the selection of a known material based on its suitability for its intended use supported a *prima facie* obviousness determination in *Sinclair & Carroll Co. v. Interchemical Corp.*, 325 U.S. 327, 65 USPQ 297 (1945). Since the disclosed material is cited in a published patent, there is no doubt that it was a known material at the time of the invention.

The applicant argues that one of ordinary skill in the art would not have been motivated to incorporate the SiloxiraneTM taught by Keehan into Wong because of differences in the epoxy resin taught by Wong and the SiloxiraneTM epoxy resin taught by Keehan, in particular the coefficient of thermal expansion (CTE). The applicant points out that the epoxy resin taught by Wong is higher than that of Keehan, which results in there being no need to add silica filler to reduce the CTE, as taught in Wong. This seems to be an added motivation for replacing the epoxy resin taught by Wong with the SiloxiraneTM epoxy resin taught by Keehan, since there is a lower CTE and there is no need to add silica filler, which results in fewer process steps and can result in lower production costs. The applicant further argues that Keehan does not teach that the CTE of the Siloxirane[™] is in the CTE range desirable for use as a no-flow underfill material. Keehan teaches other features that make SiloxiraneTM desirable for use as a no-flow underfill material, such as, enhanced chemical and corrosion resistance, high adhesive strength, high heat deflection temperatures and toughness (Keehan, Col. 3. lines 17-19). Keehan further teaches that it is an ideal encapsulant for electronic equipment (Col. 3, lines 50 and 51).

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Conclusion

7. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Douglas W Owens whose telephone number is 703-308-6167. The examiner can normally be reached on Monday-Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas can be reached on 703-308-2772. The fax phone numbers for the organization where this application or proceeding is assigned are 703-308-7722 for regular communications and 703-308-7722 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

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DWO November 17, 2002

TOM THOMAS
SUPERVISORY PATENT EXAMINER
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